Product data sheet

1. General description

N-channel enhancement mode Field-Effect Transistor (FET) in a small SOT23 (TO-236AB) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

2. Features and benefits

- Very fast switching
- Trench MOSFET technology
- ESD protected

3. Applications

- · Relay driver
- · High-speed line driver
- Low-side loadswitch
- Switching circuits

4. Quick reference data

Table 1. Quick reference data

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Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{DS}	drain-source voltage	T _j = 25 °C		-	-	60	V
V_{GS}	gate-source voltage			-20	-	20	V
I _D	drain current	V _{GS} = 10 V; T _{sp} = 25 °C		-	-	300	mA
		V _{GS} = 10 V; T _{amb} = 25 °C	[1]	-	-	190	mA
Static characte	eristics		,				
R _{DSon}	drain-source on-state resistance	$V_{GS} = 10 \text{ V}; I_D = 100 \text{ mA}; T_j = 25 \text{ °C}$		-	3	4.5	Ω

^[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 1 cm².



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5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate	3	D I
2	S	source		
3	D	drain	1 2 TO-236AB (SOT23)	G S 017aaa255

6. Ordering information

Table 3. Ordering information

Type number	Package					
	Name	Description	Version			
NX7002AK	TO-236AB	plastic surface-mounted package; 3 leads	SOT23			

7. Marking

Table 4. Marking codes

Type number	Marking code [1]
NX7002AK	%CM

[1] % = placeholder for manufacturing site code

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8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Parameter	Conditions		Min	Max	Unit
drain-source voltage	T _j = 25 °C		-	60	V
gate-source voltage			-20	20	V
drain current	V _{GS} = 10 V; T _{sp} = 25 °C		-	300	mA
	V _{GS} = 10 V; T _{amb} = 25 °C	[1]	-	190	mA
	V _{GS} = 10 V; T _{amb} = 100 °C	[1]	-	120	mA
peak drain current	T_{amb} = 25 °C; single pulse; $t_p \le 10 \mu s$		-	760	mA
total power dissipation	T _{amb} = 25 °C	[2]	-	265	mW
		[1]	-	325	mW
	T _{sp} = 25 °C		-	1330	mW
junction temperature			-55	150	°C
ambient temperature			-55	150	°C
storage temperature			-65	150	°C
diode		1			
source current	T _{amb} = 25 °C	[1]	-	190	mA
	drain-source voltage gate-source voltage drain current peak drain current total power dissipation junction temperature ambient temperature storage temperature diode	$ \begin{array}{lll} drain\text{-source voltage} & T_j = 25 \ ^\circ\text{C} \\ \\ gate\text{-source voltage} \\ \\ drain \ current & V_{GS} = 10 \ \text{V}; \ T_{sp} = 25 \ ^\circ\text{C} \\ \hline V_{GS} = 10 \ \text{V}; \ T_{amb} = 25 \ ^\circ\text{C} \\ \hline V_{GS} = 10 \ \text{V}; \ T_{amb} = 100 \ ^\circ\text{C} \\ \hline \\ peak \ drain \ current & T_{amb} = 25 \ ^\circ\text{C}; \ single \ pulse; \ t_p \leq 10 \ \mu\text{s} \\ \hline total \ power \ dissipation & T_{amb} = 25 \ ^\circ\text{C} \\ \hline \\ junction \ temperature & \\ ambient \ temperature & \\ storage \ temperature & \\ \\ \hline \\ \ diode & \\ \hline \end{array} $	$ \begin{array}{c} \text{drain-source voltage} \\ \text{gate-source voltage} \\ \\ \text{drain current} \\ \\ \hline \\ & \begin{array}{c} V_{GS} = 10 \text{ V}; T_{sp} = 25 ^{\circ}\text{C} \\ \\ \hline V_{GS} = 10 \text{ V}; T_{amb} = 25 ^{\circ}\text{C} \\ \hline V_{GS} = 10 \text{ V}; T_{amb} = 100 ^{\circ}\text{C} \\ \hline \\ V_{GS} = 10 \text{ V}; T_{amb} = 100 ^{\circ}\text{C} \\ \hline \\ \text{I1} \\ \hline \\ \text{peak drain current} \\ \hline \\ \text{total power dissipation} \\ \hline \\ & \begin{array}{c} T_{amb} = 25 ^{\circ}\text{C}; \text{single pulse}; t_p \leq 10 \mu\text{s} \\ \hline \\ \text{I1} \\ \hline \\ T_{sp} = 25 ^{\circ}\text{C} \\ \hline \\ \text{junction temperature} \\ \hline \\ \text{ambient temperature} \\ \hline \\ \text{storage temperature} \\ \hline \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ $	$ \begin{array}{c} \text{drain-source voltage} \\ \text{gate-source voltage} \\ \text{drain current} \\ \end{array} \begin{array}{c} V_{GS} = 10 \text{ V}; T_{sp} = 25 ^{\circ}\text{C} \\ \hline V_{GS} = 10 \text{ V}; T_{amb} = 25 ^{\circ}\text{C} \\ \hline V_{GS} = 10 \text{ V}; T_{amb} = 25 ^{\circ}\text{C} \\ \hline V_{GS} = 10 \text{ V}; T_{amb} = 100 ^{\circ}\text{C} \\ \hline 11 \\ \hline 1 \\ \hline $	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$

- Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 1 cm².
- [2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

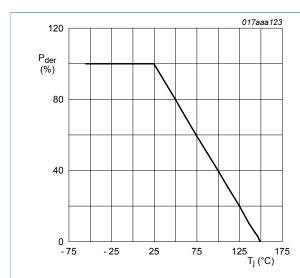


Fig. 1. Normalized total power dissipation as a function of junction temperature

$$P_{der} = \frac{P_{tot}}{P_{tot(25^{\circ}C)}} \times 100 \%$$

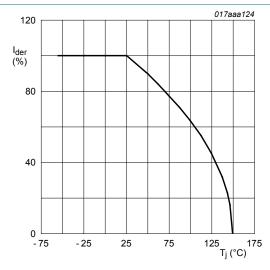


Fig. 2. Normalized continuous drain current as a function of junction temperature

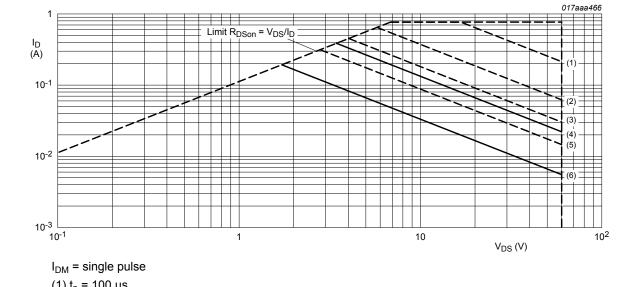
$$I_{der} = \frac{I_D}{I_{D(25^{\circ}C)}} \times 100 \%$$

NX7002AK

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(1) $t_p = 100 \ \mu s$

(2) $t_p = 1 \text{ ms}$

(3) $t_p = 10 \text{ ms}$

(4) DC; T_{sp} = 25 °C

 $(5) t_p = 100 \text{ ms}$

(6) DC; T_{amb} = 25 °C; drain mounting pad 1 cm²

Safe operating area; junction to ambient; continuous and peak drain currents as a function of drainsource voltage

Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from junction to ambient		[1]	-	410	470	K/W
			[2]	-	330	380	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point			-	-	95	K/W

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 1 cm².

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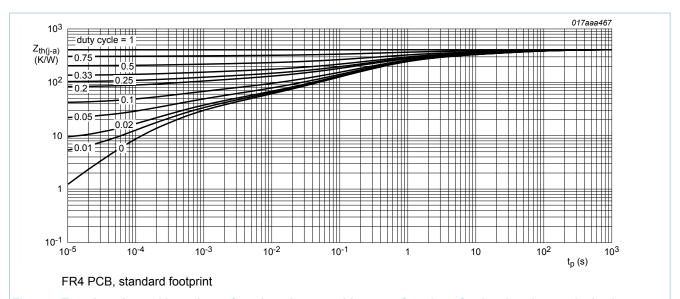


Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

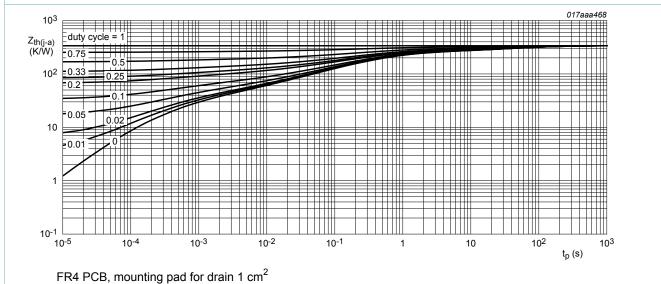


Fig. 5. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

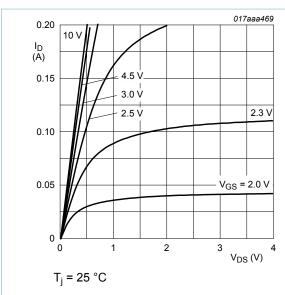
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10. Characteristics

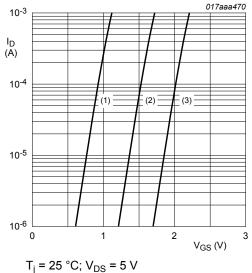
Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static char	acteristics					
$V_{(BR)DSS}$	drain-source breakdown voltage	$I_D = 250 \mu A; V_{GS} = 0 V; T_j = 25 °C$	60	-	-	V
V_{GSth}	gate-source threshold voltage	I _D = 250 μA; V _{DS} = V _{GS} ; T _j = 25 °C	1.1	1.6	2.1	V
I _{DSS}	drain leakage current	V _{DS} = 60 V; V _{GS} = 0 V; T _j = 25 °C	-	-	1	μA
		V _{DS} = 60 V; V _{GS} = 0 V; T _j = 150 °C	-	-	10	μA
I _{GSS}	gate leakage current	V _{GS} = 20 V; V _{DS} = 0 V; T _j = 25 °C	-	-	2	μA
		V_{GS} = -20 V; V_{DS} = 0 V; T_j = 25 °C	-	-	-2	μA
		V _{GS} = 10 V; V _{DS} = 0 V; T _j = 25 °C	-	-	0.5	μA
		V _{GS} = -10 V; V _{DS} = 0 V; T _j = 25 °C	-	-	-0.5	μA
		V _{GS} = 5 V; V _{DS} = 0 V; T _j = 25 °C	-	-	100	nA
		$V_{GS} = -5 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	-	-100	nA
R _{DSon} drain-source resistance	drain-source on-state	V _{GS} = 10 V; I _D = 100 mA; T _j = 25 °C	-	3	4.5	Ω
	resistance	V _{GS} = 10 V; I _D = 100 mA; T _j = 150 °C	-	6.2	9.2	Ω
		V _{GS} = 5 V; I _D = 100 mA; T _j = 25 °C	-	3.7	5.2	Ω
9 _{fs}	forward transconductance	V_{DS} = 10 V; I_{D} = 200 mA; T_{j} = 25 °C	-	500	-	mS
Dynamic cl	haracteristics		·			
Q _{G(tot)}	total gate charge	V _{DS} = 30 V; I _D = 200 mA; V _{GS} = 4.5 V;	-	0.33	0.43	nC
Q_{GS}	gate-source charge	T _j = 25 °C	-	0.12	-	nC
Q_{GD}	gate-drain charge		-	0.09	-	nC
C _{iss}	input capacitance	V _{DS} = 10 V; f = 1 MHz; V _{GS} = 0 V;	-	15	20	pF
C _{oss}	output capacitance	T _j = 25 °C	-	3.4	-	pF
C _{rss}	reverse transfer capacitance		-	2	-	pF
t _{d(on)}	turn-on delay time	V_{DS} = 40 V; R_L = 250 Ω ; V_{GS} = 10 V;	-	6	12	ns
t _r	rise time	$R_{G(ext)} = 6 \Omega; T_j = 25 °C$	-	7	-	ns
t _{d(off)}	turn-off delay time		-	11	20	ns
t _f	fall time		-	5	-	ns
Source-dra	in diode		'			,
V_{SD}	source-drain voltage	I _S = 115 mA; V _{GS} = 0 V; T _i = 25 °C	0.47	0.8	1.2	V

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Output characteristics: drain current as a Fig. 6. function of drain-source voltage; typical values



- (1) minimum values
- (2) typical values
- (3) maximum values

Sub-threshold drain current as a function of Fig. 7. gate-source voltage

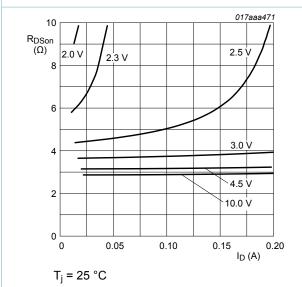
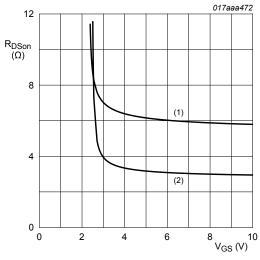


Fig. 8. Drain-source on-state resistance as a function of drain current; typical values



 $I_D = 0.2 A$

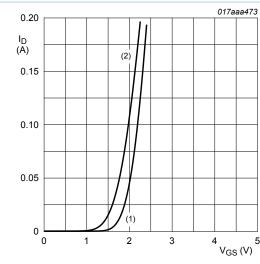
(1) $T_i = 150 \, ^{\circ}C$

(2) $T_i = 25 \, ^{\circ}C$

Fig. 9. Drain-source on-state resistance as a function of gate-source voltage; typical values

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 $V_{DS} > I_D \times R_{DSon}$ (1) $T_i = 25 \,^{\circ}C$

(2) $T_i = 150 \, ^{\circ}C$

Fig. 10. Transfer characteristics: drain current as a function of gate-source voltage; typical values

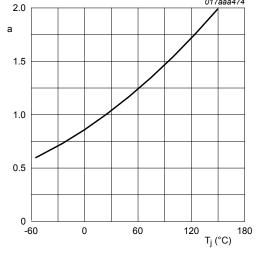
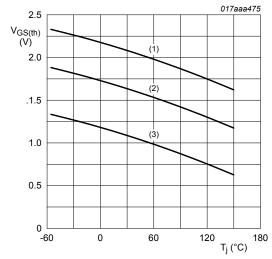


Fig. 11. Normalized drain-source on-state resistance as a function of junction temperature; typical values

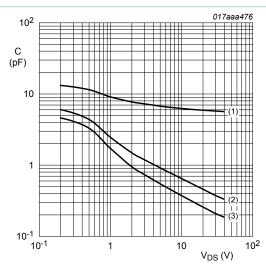
$$a = \frac{R_{DSon}}{R_{DSon(25^{\circ}C)}}$$



 I_D = 0.25 mA; V_{DS} = V_{GS}

- (1) maximum values
- (2) typical values
- (3) minimum values

Fig. 12. Gate-source threshold voltage as a function of junction temperature



 $f = 1 MHz; V_{GS} = 0 V$

- $(1) C_{iss}$
- (2) C_{oss}
- (3) C_{rss}

Fig. 13. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values

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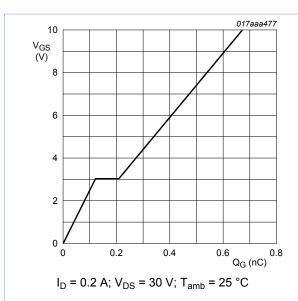


Fig. 14. Gate-source voltage as a function of gate charge; typical values

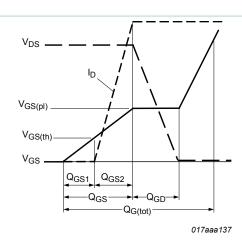
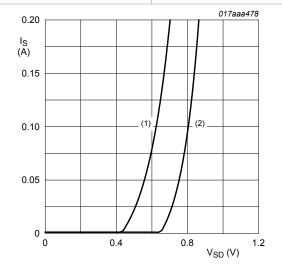


Fig. 15. MOSFET transistor: Gate charge waveform definitions



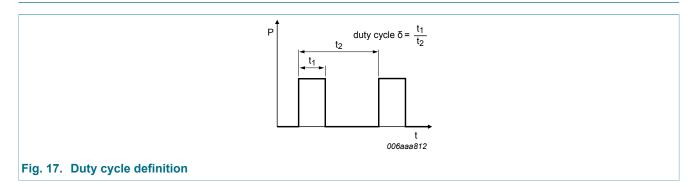
 $V_{GS} = 0 V$ (1) $T_j = 150 \,^{\circ}C$

(2) $T_i = 25 \, ^{\circ}C$

Fig. 16. Source current as a function of source-drain voltage; typical values

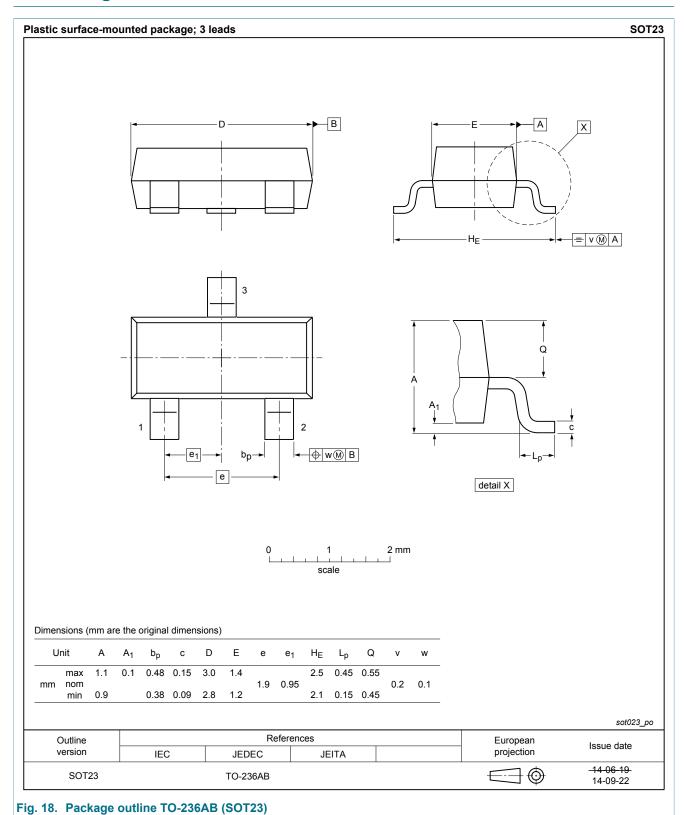
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11. Test information



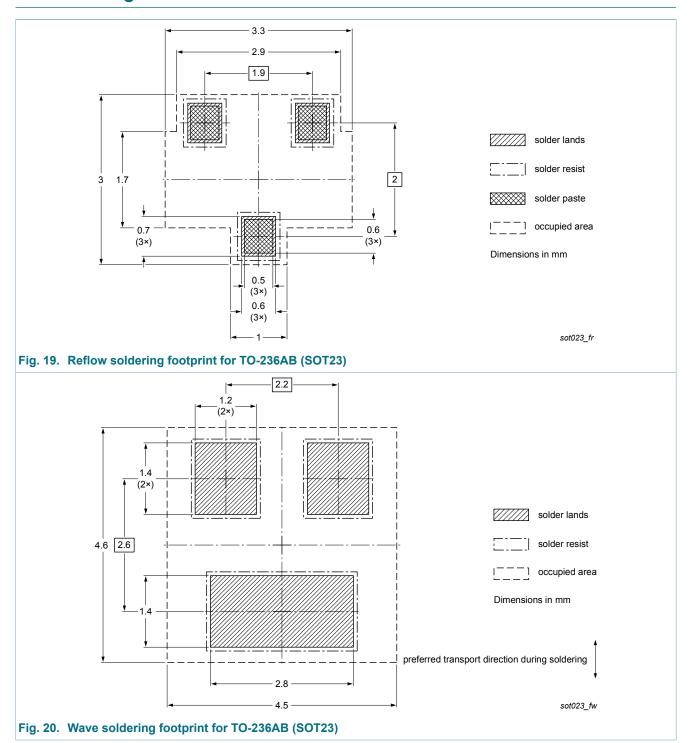
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12. Package outline



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13. Soldering



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14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
NX7002AK v.7	20150806	Product data sheet	-	NX7002AK v.6
Modifications:	Dynamic parameter	rs updated		
NX7002AK v.6	20150521	Product data sheet	-	NX7002AK v.5
NX7002AK v.5	20130213	Product data sheet	-	NX7002AK v.4
NX7002AK v.4	20121213	Product data sheet	-	NX7002AK v.3
NX7002AK v.3	20120710	Product data sheet	-	NX7002AK v.2
NX7002AK v.2	20120301	Product data sheet	-	NX7002AK v.1
NX7002AK v.1	20120212	Product data sheet	-	-

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15. Legal information

15.1 Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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